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S/N 09/726,629

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Ajit V. Sathe et al.

Examiner: Xuan Marian Thai

Serial No.:

09/726,629

Group Art Unit: 2111

Filed:

November 30, 2000

Docket No.: 884.341US1

Title:

SOLDERLESS ELECTRONICS PACKAGING (As Amended)

Assignee:

Intel Corporation

Customer No: 21186

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

This responds to the Office Action mailed on February 11, 2004. Please amend the above-identified patent application as follows.

This response is accompanied by a Petition, as well as the appropriate fee, to obtain a one-month extension of the period for responding to the Office action, thereby moving the deadline for response from May 11, 2004 to June 11, 2004. Because the U.S. Patent & Trademark Office was closed on June 11, 2004, in honor of President Reagan's funeral, the due date is extended to June 14, 2004.